

LQH43NH100J03L Datasheet

DiGi Electronics Part Number

Manufacturer Product Number

Manufacturer

Description

Detailed Description

LQH43NH100J03L-DG

Murata Electronics

LQH43NH100J03L

FIXED IND 10UH 480MA 240MOHM SMD

10 μH Unshielded Drum Core, Wirewound Inductor 480 mA 240mOhm Max 1812 (4532 Metric)

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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
LQH43NH100J03L	Murata Electronics
Series:	Product Status:
LQH43	Discontinued at Digi-Key
Туре:	Material - Core:
Drum Core, Wirewound	Ferrite
Inductance:	Tolerance:
10 µН	±5%
Current Rating (Amps):	Current - Saturation (Isat):
480 mA	
Shielding:	DC Resistance (DCR):
Unshielded	240mOhm Max
Q @ Freq:	Frequency - Self Resonant:
35 @ 1MHz	23MHz
Ratings:	Operating Temperature:
AEC-Q200	-40°C ~ 125℃
Inductance Frequency - Test:	Features:
1 MHz	-
Mounting Type:	Package / Case:
Surface Mount	1812 (4532 Metric)
Supplier Device Package:	Size / Dimension:
1812	0.177" L x 0.126" W (4.50mm x 3.20mm)
Height - Seated (Max):	Base Product Number:
0.110" (2.80mm)	LQH43NH

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8504.50.8000	

Reference Only

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CHIP COIL (CHIP INDUCTORS) LQH43NH 00003L Murata Standard Reference Specification [AEC-Q200]

1.Scope

This reference specification applies to LQH43NH series, Chip coil (Chip Inductors) for automotive Electronics based on AEC-Q200.

2.Part Numbering

(ex) <u>LQ</u> Product IE	H 43 Dimension (L×W)	and	ions Cate	H egory Ir	1R0 nductance	M Tolerance Fe	0 3 atures Electro	ode Packag L:Tapir	-
	emperature Range.		0°C to ∘						
Storage Ter	nperature Range.		0°C to	+125 °(0.1		
Customer's Part Number	MURATA Part Number	Ind (μH)	uctance Tolerance (%)	Q (min.)	DC Re (Ω)	Tolerance (%)	Self Resonant Frequency (MHz min)	*1:Rated Current (mA)	ESD 5A: 8kV
	LQH43NH1R0M03L	1.0	M: ±20		0.033		120	1300	
	LQH43NH1R2K03L	1.2	K: ±10		0.043	_	100	1100	
	LQH43NH1R5J03L	1.5			0.049	-	85	1000	
	LQH43NH1R8J03L	1.8			0.043	-	75	1050	
	LQH43NH2R2J03L	2.2		20	0.049	-	62	1000	
	LQH43NH2R7J03L	2.7			0.053	-	53	950	
	LQH43NH3R3J03L	3.3			0.077	-	47	800	
	LQH43NH3R9J03L	3.9			0.12	-	41	650	
	LQH43NH4R7J03L	4.7			0.090	-	38	750	
	LQH43NH5R6J03L	5.6		25	0.11	-	33	650	
	LQH43NH6R8J03L	6.8		20	0.18	-	31	530	
	LQH43NH8R2J03L	8.2		30	0.18	-	27	530	
	LQH43NH100J03L	10			0.20	-	23	480	
	LQH43NH120J03L	12			0.25	±20	21	420	5A
	LQH43NH150J03L	15	J: ±5		0.30	-	19	390	
	LQH43NH180J03L	18			0.35	-	17	365	
	LQH43NH220J03L	22			0.47	-	15	300	
	LQH43NH270J03L	27		25	0.60	-	14	280	
	LQH43NH330J03L	33		35	0.70	-	12	250	
	LQH43NH390J03L	39			0.80	-	11	230	
	LQH43NH470J03L	47			0.87	-	10	210	
	LQH43NH560J03L	56			1.34	-	9.3	180	
	LQH43NH680J03L	68			1.52	-	8.4	170	
	LQH43NH820J03L	82			1.70	-	7.5	165	
	LQH43NH101J03L	100			2.00	-	6.8	150	
	LQH43NH121J03L	120		40	2.60	4	6.2	130	
	LQH43NH151J03L	150			3.00		5.5	120	

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Customer's	ΜΠΒΑΤΑ	Inductance		MURATA Inductance		Q	DC Re	sistance	Self Resonant	*1:Rated	ESD
Part Number	Part Number	(µH)	Tolerance (%)	(min.)	(Ω)	Tolerance (%)	Frequency (MHz min)	Current (mA)	5A: 8kV		
	LQH43NH181J03L	180			3.40		5.0	110			
	LQH43NH221J03L	220			3.80		4.5	100			
	LQH43NH271J03L	270			5.50		4.0	90			
	LQH43NH331J03L	330			6.20		3.6	85			
	LQH43NH391J03L	390			6.90		3.3	80			
	LQH43NH471J03L	470			7.80		3.0	75			
	LQH43NH561J03L	560			11.3		2.7	60			
	LQH43NH681J03L	680	J: ±5	40	12.9	±20	2.5	55	5A		
	LQH43NH821J03L	820			14.5		2.2	50			
	LQH43NH102J03L	1000			15.5		2.0	45			
	LQH43NH122J03L	1200			20.3		1.8	40			
	LQH43NH152J03L	1500			23.7		1.6	35			
	LQH43NH182J03L	1800			26.7		1.5	35			
	LQH43NH222J03L	2200			30.6		1.3	30			

*1:When applied Rated current to the Products, self temperature rise shall be limited to 20°C max and Inductance will be within

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±10% of nominal value.

4. Testing Conditions

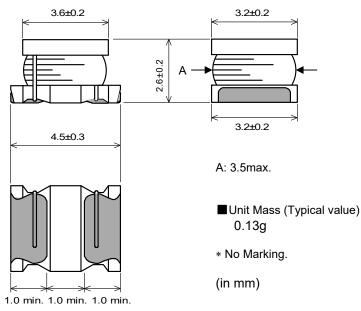
《Unless otherwise specified》

Temperature: Ordinary Temperature / 15°C to 35°CHumidity: Ordinary Humidity / 25%(RH) to 85%(RH)

In case of doubt》	
Temperature	: 20 ± 2
Humidity	: 60%(F
Atmospheric Pressure	: 86kPa

: 20 ± 2°C : 60%(RH) to 70%(RH) : 86kPa to 106 kPa

5. Appearance and Dimensions (No marking)



Reference Only

6. Electrical Performance

No.	Item	Specification	Test Method
6.1	Inductance	Inductance shall meet item 3.	Measuring Equipment: KEYSIGHT 4192A or equivalent Measuring Frequency: 1MHz / 1.0 to 390µH 1kHz / 470 to 2200µH
6.2	Q	Q shall meet item 3.	Measuring Equipment: KEYSIGHT 4192A or equivalent Measuring Frequency: 1MHz / 1.0 to 82µH 796kHz / 100 to 820µH 252kHz / 1000 to 2200µH
6.3	DC Resistance	DC Resistance shall meet item 3.	Measuring Equipment:Digital multi meter
6.4	Self Resonant Frequency(S.R.F)	S.R.F shall meet item 3.	Measuring Equipment: KEYSIGHT E4991A or equivalent

7. AEC-Q200 Requirement

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7.1 Performance (based on Table 5 for Magnetics(Inductors / Transformer) AEC-Q200 Rev.D issued June. 1 2010

	AEC-Q200			Murata Specification / Deviation		
No	Stress Test Method					
3	High	1000hours at 125 deg C		A after testing.		
	Temperature Exposure	Set for 24hours at room temperature, then measured.	Table A	Appearance	No damage	
				Inductance change	Within ±10%	
4	Temperature Cycling	1000cycles -40 deg C to + 125 deg C Set for 24hours at room temperature,then measured.	Meet Table	Meet Table A after testing.		
7	Biased Humidity	1000hours at 85 deg C, 85%RH unpowered.	Meet Table	Meet Table A after testing.		
8	Operational Life	Apply 125 deg C 1000 hours Set for 24hours at room temperature, then measured	Meet Table	Meet Table A after testing.		
9	External Visual	Visual inspection	No abnorma	No abnormalities		
10	Physical Dimension	Meet ITEM 5 (Appearance and Dimensions)	No defects			
12	Resistance to Solvents	Per MIL-STD-202 Method 215	Not Applicable			
13	Mechanical Shock	Per MIL-STD-202 Method 213 100g's/6ms/Half sine	Meet Table A after testing.			
14	Vibration	5g's for 20 minutes, 12cycles eah of 3 orientations Test from 10-2000Hz. 12cycles each of 3 orientations	Meet Table	A after testing.		
15	Resistance to Soldering Heat	No-heating Solder temperature 260C+/-5 deg C Immersion time 10s	Meet Table	A after testing.		
17	ESD	Per AEC-Q200-002	Meet Item 3 (Rating) No defects			
18	Solderbility	Per J-STD-002	Method B : Not Applicable 95% of the terminations is to be soldered. (Except exposed wire)			
19	Electrical Characterization	Measured : Inductance	No defects			

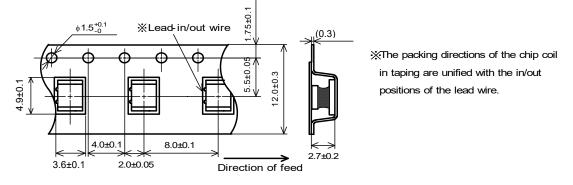
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	ŀ	AEC-Q200	Murata Specification / Deviation		
No	Stress	Test Method	Murata Specification / Deviation		
20	Flammability	Per UL-94	Not Applicable		
21	Board Flex	Epoxy-PCB(1.6mm) Deflection 2mm(min) 60s minimum holding time	Murata deviation request: 5s Meet Table B after testing. <u>Table B</u>		
			Appearance No damage		
			DC resistance change Within ±10%		
22	Terminal Strength	Per AEC-Q200-006 A force of 17.7N for 60s	No defects		

8. Specification of Packaging

8.1 Appearance and Dimensions of plastic tape



Dimension of the Cavity is measured at the bottom side.

8.2 Specification of Taping

(1) Packing quantity (standard quantity)

- 500 pcs / reel
- (2) Packing Method
- Products shall be packed in the each embossed cavity of plastic tape and sealed by cover tape. (3) Sprocket hole
 - The sprocket holes are to the right as the tape is pulled toward the user.
- (4) Spliced point
 - Plastic tape and Cover tape has no spliced point.
- (5) Missing components number

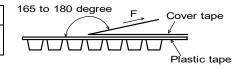
Missing components number within 0.025 % of the number per reel or 1 pc., whichever is greater, and are not continuous. The specified quantity per reel is kept.

8.3 Pull Strength

Plastic tape	10N min.
Cover tape	5N min.

8.4 Peeling off force of cover tape

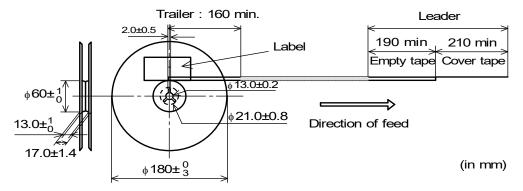
Speed of Peeling off	300mm / min
Peeling off force	0.2N to 0.7N (minimum value is typical)



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8.5 Dimensions of Leader-tape, Trailer and Reel

There shall be leader-tape (cover tape) and trailer-tape (empty tape) as follows.



8.6 Marking for reel

Customer part number, MURATA part number, Inspection number(*1), RoHS marking(*2), Quantity etc ···

<u>
 0000 ×××</u>

(2)

: Year / Last digit of year

(3)

: Month / Jan. to Sep. \rightarrow 1 to 9, Oct. to Dec. \rightarrow O, N, D

(1)

*1) < Expression of Inspection No.>

- (1) Factory Code
- (2) Date

First digit : Year Second digit : Mon Third, Fourth digit : Day

(3) Serial No.

*2) « Expression of RoHS marking » ROHS – \underline{Y} ($\underline{\triangle}$) (1) (2)

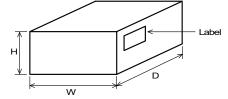
(1) RoHS regulation conformity

(2) MURATA classification number

8.7 Marking for Outside package (corrugated paper box)

Customer name, Purchasing order number, Customer part number, MURATA part number, RoHS marking (*2) ,Quantity, etc ····

8.8. Specification of Outer Case



I	Outer Ca	se Dimensi	Standard Reel Quantity	
	W	D	Н	in Outer Case (Reel)
	186	186	93	5

*Above Outer Case size is typical. It depends on a quantity of an order

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_QH43NH100J03L Mura

Spec No. JELF243A-9150B-01



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9. \Lambda Caution

9.1 Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Power plant control equipment
- (5) Medical equipment
- (7) Traffic signal equipment(8) Transportation equipment (trains, ships, etc.)
- (9) Applications of similar complexity and /or reliability

(6) Disaster prevention / crime prevention equipment

requirements to the applications listed in the above

9.2 Caution(Rating)

Do not exceed maximum rated current of the product. Thermal stress may be transmitted to the product and short/open circuit of the product or falling off the product may be occurred.

9.3 Fail-safe

Be sure to provide an appropriate fail-safe function on your product to prevent a second damage that may be caused by the abnormal function or the failure of our product.

9.4 Corrosive gas

Please refrain from use since contact with environments with corrosive gases (sulfur gas [hydrogen sulfide, sulfur dioxide, etc.], chlorine, ammonia, etc.) or oils (cutting oil, silicone oil, etc.) that have come into contact with the previously stated corrosive gas environment will result in deterioration of product quality or an open from deterioration due to corrosion of product electrode, etc. We will not bear any responsibility for use under these environments.

10. Notice

This product is designed for solder mounting.

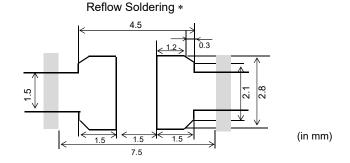
Please consult us in advance for applying other mounting method such as conductive adhesive.

10.1 Land pattern designing

Recommended land patterns for reflow soldering are as follows:

It has been designed for Electric characteristics and solderability.

Please follow the recommended pattern. Otherwise, their performance which includes electrical performance or solderability may be affected, or result to "position shift" in soldering process.



10.2 Flux, Solder

Flux	 Use rosin-based flux. Don't use highly acidic flux with halide content exceeding 0.2(wt)% (chlorine conversion value). Don't use water-soluble flux.
Solder	 Use Sn-3.0Ag-0.5Cu solder Standard thickness of solder paste : 200µm to 300µm

Other flux (except above) Please contact us for details, then use.



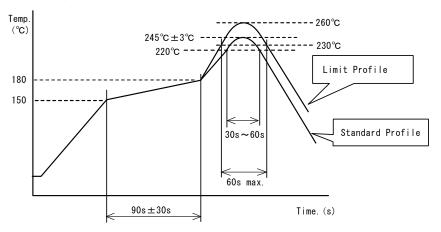
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10.3 Reflow soldering conditions

 Pre-heating should be in such a way that the temperature difference between solder and product surface is limited to 150°C max. Cooling into solvent after soldering also should be in such a way that the temperature difference is limited to 100°C max.

Insufficient pre-heating may cause cracks on the product, resulting in the deterioration of products quality.

- · Standard soldering profile and the limit soldering profile is as follows.
- The excessive limit soldering conditions may cause leaching of the electrode and / or resulting in the deterioration of product quality.
- · Reflow soldering profile



	Standard Profile	Limit Profile	
Pre-heating	150~180°C 、90s±30s		
Heating	above 220°C、30s~60s	above 230°C、60s max.	
Peak temperature	245±3°C	260°C,10s	
Cycle of reflow	2 times	2time	

10.4 Reworking with soldering iron.

The following conditions must be strictly followed when using a soldering iron.

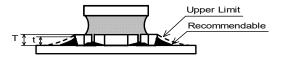
Pre-heating	150°C,1 min	
Tip temperature	350°C max.	
Soldering iron output	80W max.	
Tip diameter	ϕ 3mm max.	
Soldering time	3(+1,-0)s	
Times	2 times	

Note : Do not directly touch the products with the tip of the soldering iron in order to prevent the crack on the products due to the thermal shock.

10.5 Solder Volume

· Solder shall be used not to be exceeded the upper limits as shown below.

• Accordingly increasing the solder volume, the mechanical stress to Chip is also increased. Exceeding solder volume may cause the failure of mechanical or electrical performance.



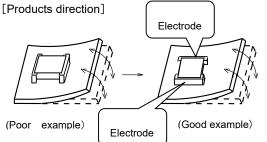
1/3T≦t≦T T: Lower flange thickness

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10.6 Product's location

- The following shall be considered when designing and laying out P.C.B.'s.
- (1) P.C.B. shall be designed so that products are not subject to the mechanical stress due to warping the board.

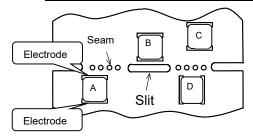


The electorode part of the products should be located like the picture to the mechanical stress.

(2) Components location on P.C.B. separation.

It is effective to implement the following measures, to reduce stress in separating the board. It is best to implement all of the following three measures; however, implement as many measures as possible to reduce stress.

Contents of Measures	Stress Level
 Turn the mounting direction of the component parallel to the board separation surface. 	A > D*1
(2) Add slits in the board separation part.	A > B
(3) Keep the mounting position of the component away from the board separation surface.	A > C



(3) Mounting Components Near Screw Holes When a component is mounted near a screw hole, it may be affected by the board deflection that occurs during the tightening of the screw. Mount the component in a position as far away from the screw holes as possible.

10.7 Cleaning Conditions

Products shall be cleaned on the following conditions.

- (1) Cleaning temperature shall be limited to 60°C max.(40°C max for alcohol type cleaner.)
- (2) Ultrasonic cleaning shall comply with the following conditions with avoiding the resonance phenomenon at the mounted products and P.C.B.
- Power : 20 W / I max. Frequency : 28kHz to 40kHz Time : 5 min max.
- (3) Cleaner

1. Alternative cleaner

- Isopropyl alcohol (IPA)
- 2. Aqueous agent
 - PINE ALPHA ST-100S
- (4) There shall be no residual flux and residual cleaner after cleaning.
- In the case of using aqueous agent, products shall be dried completely after rinse with de-ionized water in order to remove the cleaner.
- (5) Other cleaning
 - Please contact us.

Screw Hole Recommended

*1 A > D is valid when stress is added vertically to

If a Cutting Disc is used, stress will be diagonal to

the perforation as with Hand Separation.

the PCB, therefore A > D is invalid.



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10.8 Resin coating (moistureproof coating)

Do not make any resin coating.

The inductance value may change due to high cure-stress of resin to be used for coating/molding products. An open circuit issue may occur by mechanical stress caused by the resin, amount/cured shape of resin, or operating condition etc. Some resin contains some impurities or chloride possible to generate chlorine by hydrolysis under some operating condition may cause corrosion of wire of coil, leading to open circuit.

10.9 Caution for use

- Sharp material such as a pair of tweezers or other material such as bristles of cleaning brush, shall not be touched to the winding portion to prevent the breaking of wire.
- · Mechanical shock should not be applied to the products mounted on the board to prevent the breaking of the core

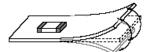
10.10 Handling of a substrate

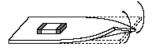
After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting to the substrate when cropping the substrate, inserting and removing a connector from the substrate or tightening screw to the substrate.

Excessive mechanical stress may cause cracking in the product.

Bending

Twisting





10.11 Storage and Handing Requirements

(1) Storage period

Use the products within 12 months after delivered.

- Solderability should be checked if this period is exceeded.
- (2) Storage conditions
 - Products should be stored in the warehouse on the following conditions.
 - Temperature : -10 °C to 40 °C

Humidity : 15 % to 85 % relative humidity No rapid change on temperature and humidity The electrode of the products is coated with solder. Don't keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in

- poor solderability.
- Products should not be stored on bulk packaging condition to prevent the chipping of the core and the breaking of winding wire caused by the collision between the products.
- Products should be stored on the palette for the prevention of the influence from humidity, dust and so on.
- Products should be stored in the warehouse without heat shock, vibration, direct sunlight and so on. (3) Handling Condition
 - Care should be taken when transporting or handling product to avoid excessive vibration or mechanical shock.

11. **A**Note

- (1) Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- (2) You are requested not to use our product deviating from the agreed specifications.
- (3) The contents of this reference specification are subject to change without advance notice. Please approve our product specifications or transact the approval sheet for product specifications before ordering.



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